

Amendments to the Claims:

This listing of claims will replace all prior versions and listing of claims in the application.

5 Listing of Claims:

Claim 1 (withdrawn): A method of fabricating an organic light emitting display device, the method comprising:

- providing a substrate;
- forming an organic light emitting unit on the substrate; and
- 10 forming a passivation structure layer including organic and inorganic contents over the organic light emitting unit and the substrate,

wherein the passivation layer is formed by supplying one or more source compound of respective ratio varying in time.

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Claim 2 (withdrawn): The method of claim 1 wherein forming the passivation structure is performed by a chemical vapor deposition (CVD) process.

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Claim 3 (withdrawn): The method of claim 2, wherein the chemical vapor deposition is a plasma enhanced chemical vapor deposition process.

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Claim 4 (withdrawn): The method of claim 1, wherein forming a passivation layer is performed by a sputtering process.

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Claim 5 (withdrawn): The method of claim 3, wherein the one or more source compound includes trimethylchlorosilane (TMCS) or hexamethyl disilazane (HMDS).

Claim 6 (withdrawn): The method of claim 4, wherein the one or more source compound includes an organic source compound and an inorganic source

compound.

Claim 7 (withdrawn): The method of claim 6, wherein the organic source compound includes PTFE.

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Claim 8 (withdrawn): The method of claim 6, wherein the inorganic source compound includes silicon oxide.

10 Claim 9 (withdrawn): The method of claim 6, wherein the ratio of the organic source compound decreases in time.

Claim 10 (withdrawn): The method of claim 6, wherein the ratio of the inorganic source compound increases in time.

15 Claim 11 (currently amended): An organic light emitting display, comprising:

a substrate;

an organic light emitting unit on the substrate, and

20 a passivation layer covering the organic light emitting unit, wherein the passivation layer is made of a material including compound reacted by organic and inorganic materials contents, the material has a plurality of organic/inorganic ratios, and each organic/inorganic ratio of the material has a different thickness, and the compound has a varied organic/inorganic ratio from an inner side of the passivation layer
25 adjacent to the organic light emitting unit to an outer side of the passivation layer.

30 Claim 12 (original): The organic light emitting display of claim 11, wherein the organic content is preponderant in a portion of the passivation layer adjacent to the organic light emitting unit.

Claim 13 (original): The organic light emitting display of claim 11,

wherein the inorganic content is preponderant in a portion of the passivation layer not in contact with the organic light emitting unit.

5 Claim 14 (original): The organic light emitting display of claim 11, wherein a thickness of the passivation layer is in a range of about 500 to 5000 angstroms.

10 Claim 15 (original): The organic light emitting display of claim 11, wherein the passivation layer includes SiO_xCyHz , SiN_xCyHz , or $\text{SiOwN}_x\text{CyHz}$ compounds.

15 Claim 16 (original): The organic light emitting display device of claim 11, wherein the passivation layer has light transmittance in a range of about 40 to 90%.